

Characterization of accelerated degradation modes: applying light and voltage bias during damp-heat exposure

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Institute of Energy Conversion

- World's oldest solar cell laboratory (1972)
- Integrated lab for fabrication, characterization, and analysis of CdTe, Cu(InGa)Se₂ (CIGS), and c-Si heterojunction solar cells and mini-modules
- Research partnerships with 45 PV and supply chain manufacturers since 2005, also national labs, and universities
- Multidisciplinary staff of scientists, engineers, technicians, and graduate students
- Capabilities relating to accelerated life testing (ALT) and reliability studies
 - Fabrication of baseline and custom-designed thin film and c-Si solar cells or mini-modules;
 - Extensive device characterization and analysis: IV, IV(T), CV(T), QE, EL, LBIC
 - Multiple chambers for controlled ambient (H₂/Ar, N₂, dry air) ALT w/ temperature, voltage, and light bias
 - Multiple chambers for damp-heat (D-H) ALT with voltage and light bias
 - In-situ and post-mortem I-V characterization and diagnosis
 - Collaborated with over 7 US companies on ALT studies: device degradation, encapsulation, transient effects



ALT system 1: Controlled ambient light and electrical bias

4 pods with 4 samples each, in-situ IV measurements



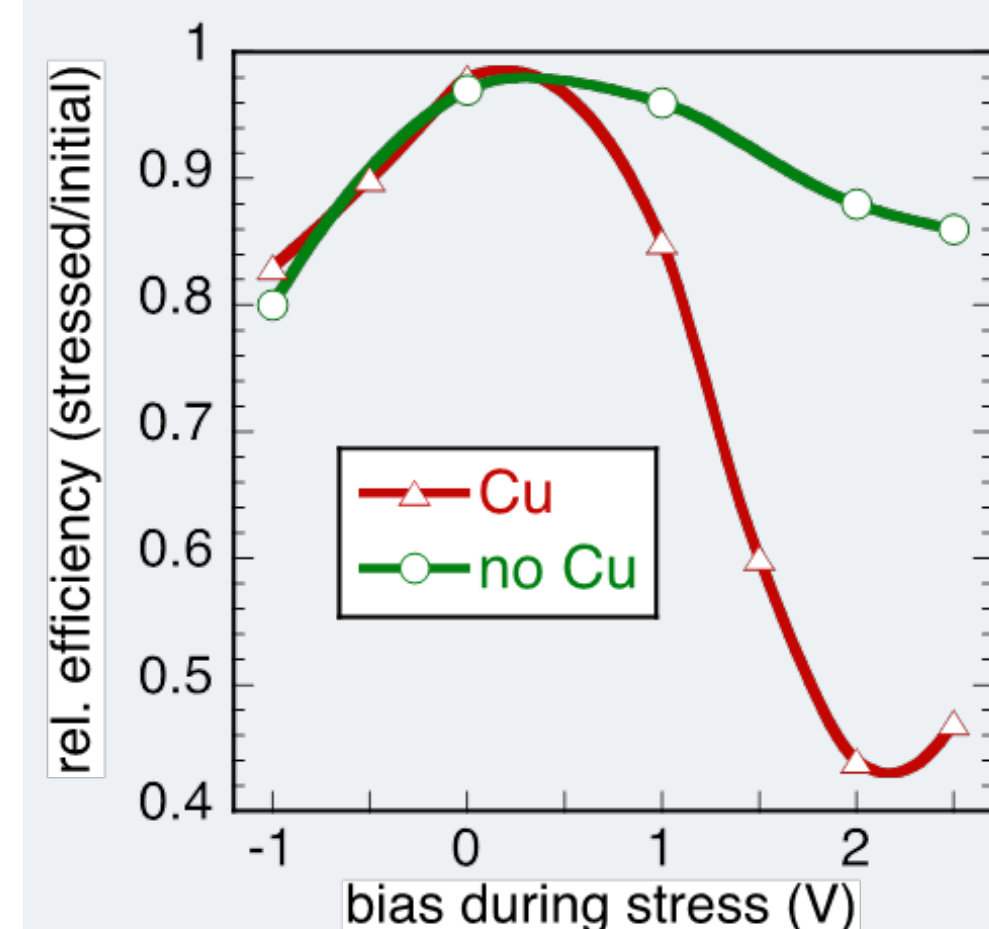
ALT system 2: Damp-Heat chambers with light and electrical bias

2 chambers, 20 samples each, in-situ IV measurements

Metastable effects in CdTe

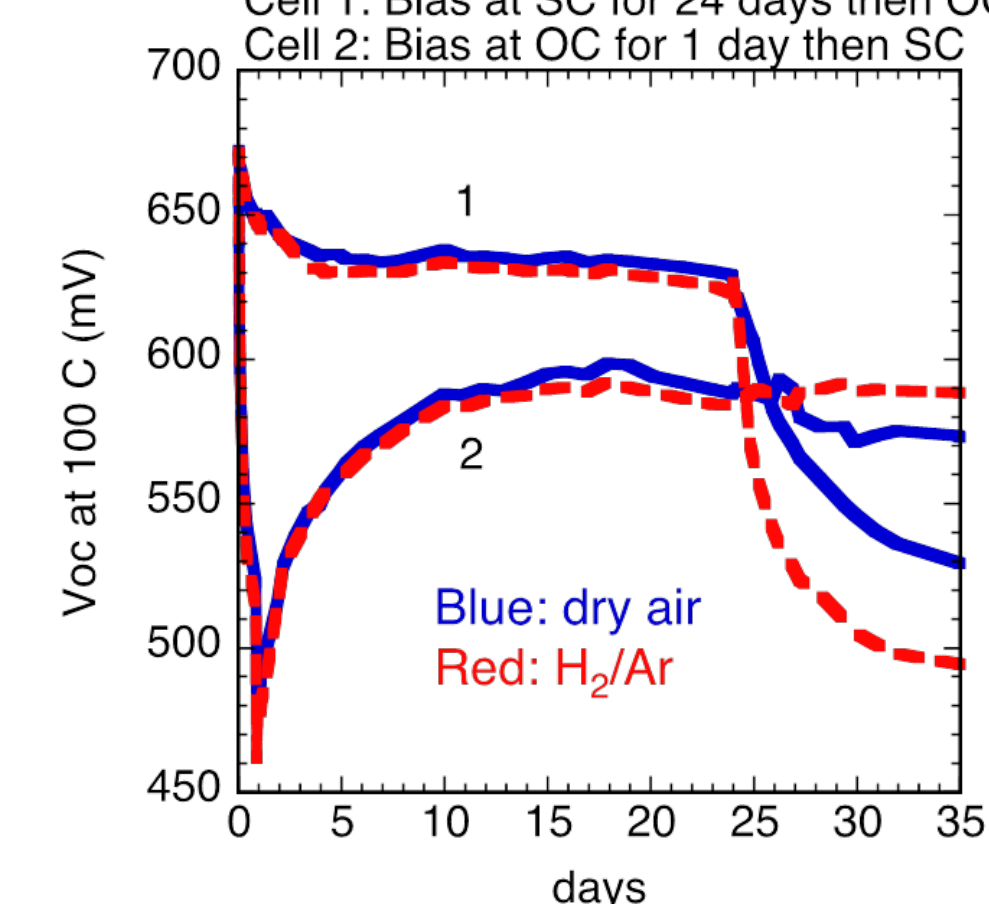
- CdTe modules with good stability demonstrated in the field
- Laboratory device commonly reported as unstable >1 week with fixed stress/bias ALT
- Field and lab exposure differ in
 - Daily temperature and light cycles
 - Ambient: Encapsulated vs uncontrolled room air humidity

Exposure: 10 days@60°C, dark, air at various applied bias voltage
Cells: CdTe from Manufacturer A with custom IEC contacts: vary Cu

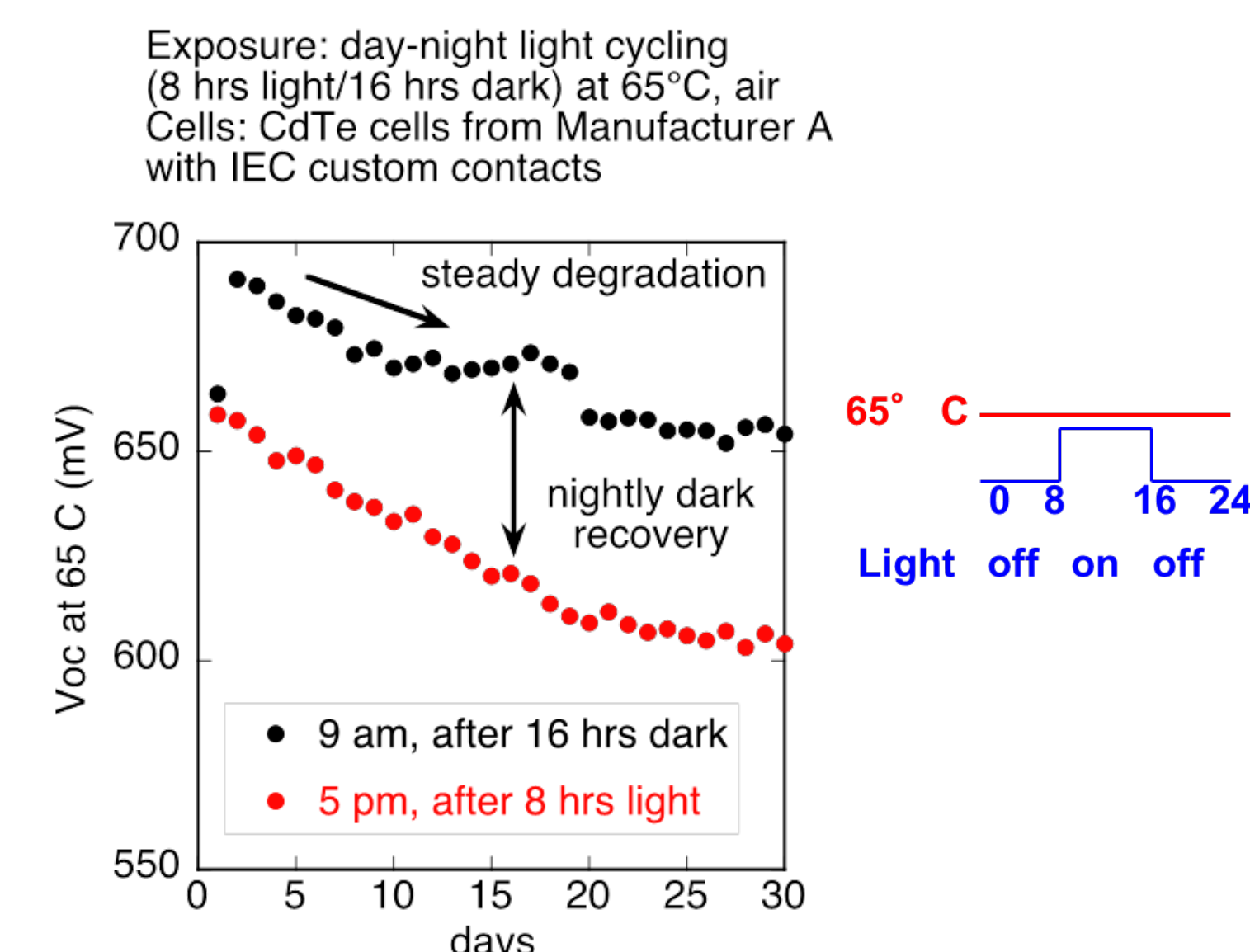


- Role of voltage bias at 60 ° C in driving Cu-induced degradation

Exposure: constant light at 100°C in dry air or H₂/Ar, vary bias
Cell 1: Bias at SC for 24 days then OC
Cell 2: Bias at OC for 1 day then SC

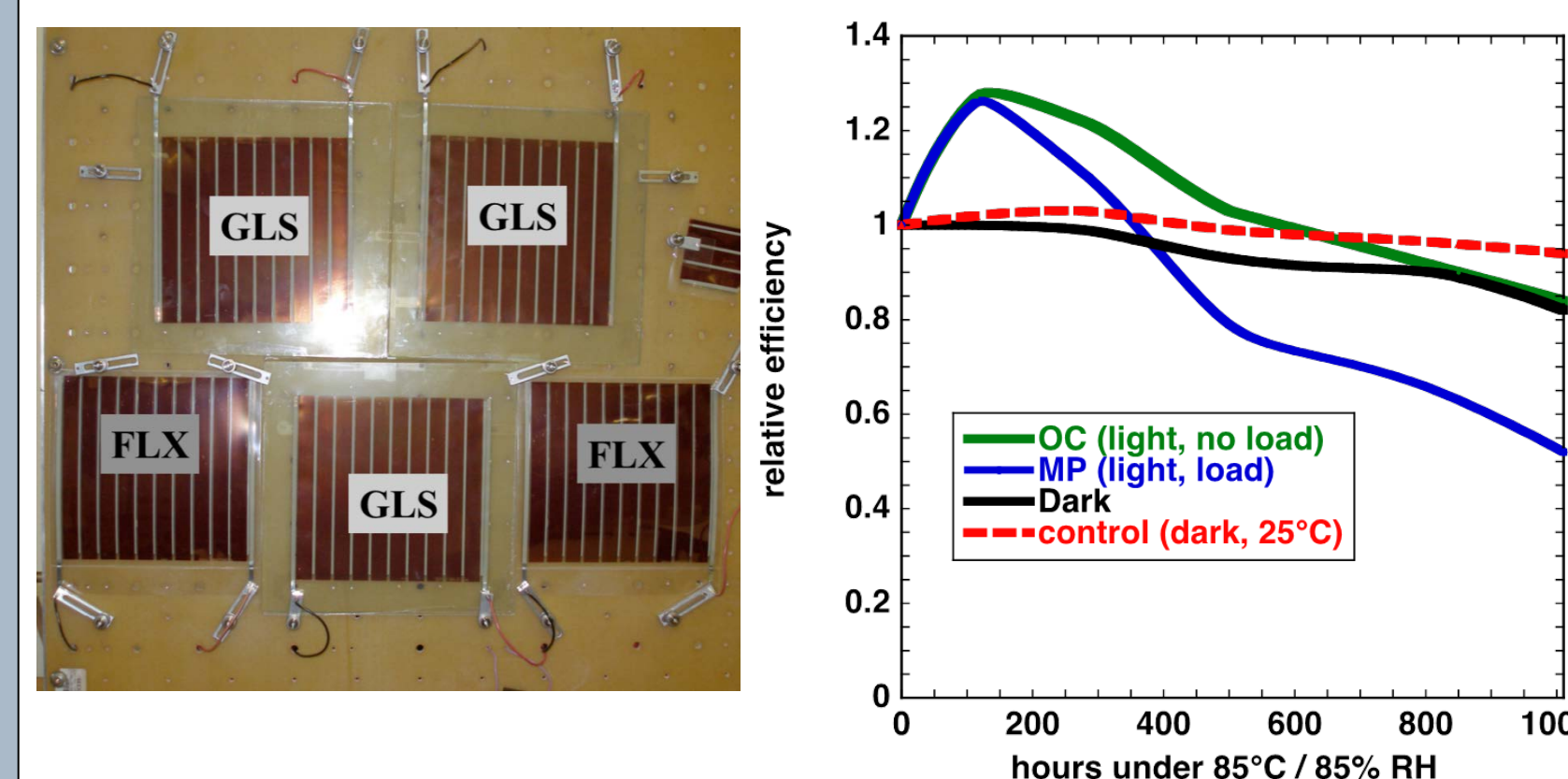


- Transient degradation and recovery: Effect of bias and ambient in CdTe from manufacturer A

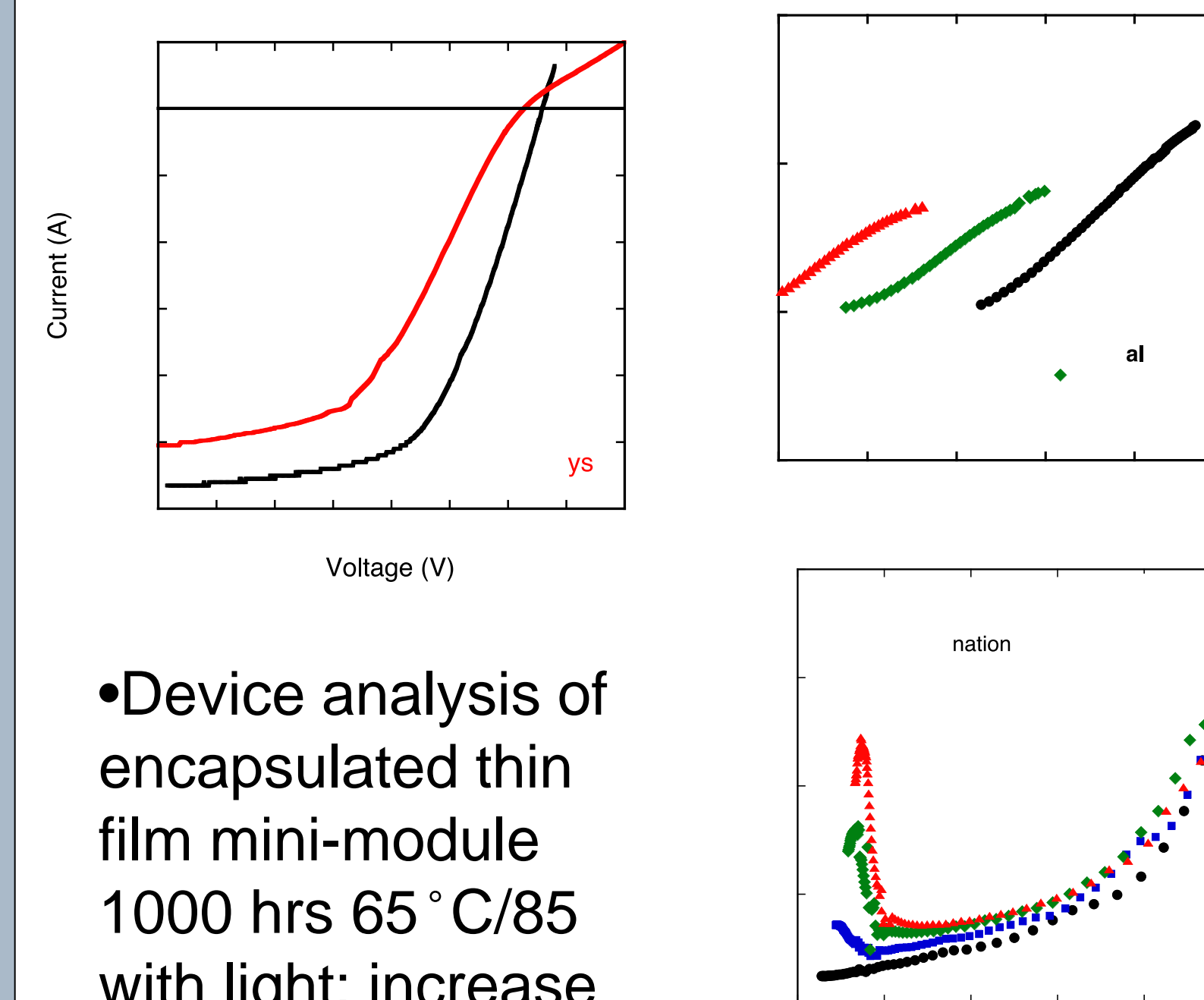


- Day-night metastability in CdTe cells: degradation and partial recovery measured in-situ during exposure
- Degradation increases with forward bias but magnitude varies with processing
- Time constant for losses faster than recovery (@ 60-100 ° C)
- Recovery within days after stress with dark storage: 'defect relaxation'
- Device analysis (not shown) separates junction and contact degradation

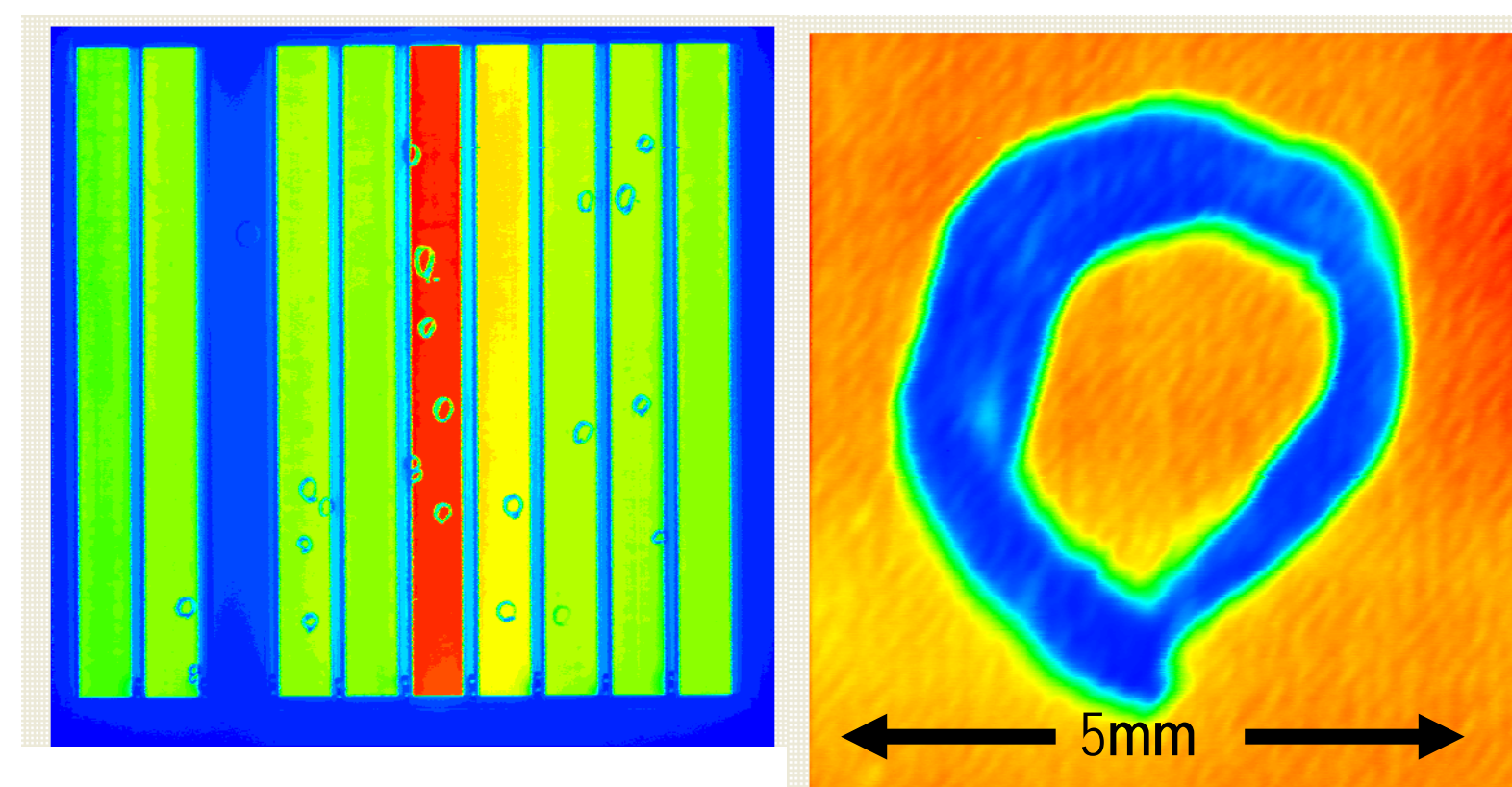
Characterization of TF module degradation



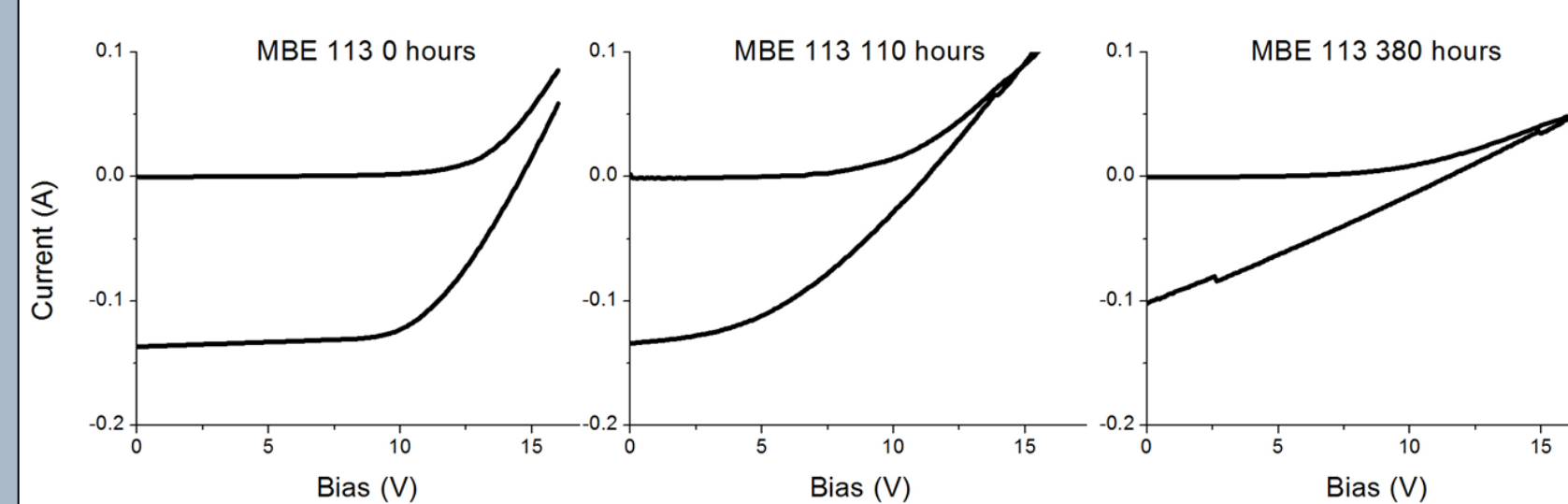
- Organic PV minimodules (6x6") from US manufacturer, glass or flex encapsulation, 1000 hrs at 85 ° C/85 %RH, dark or light, max power (MP) or open circuit (OC).
- Standard 85/85/dark ALT condition not representative of realistic load at MP, OC



- Device analysis of encapsulated thin film mini-module 1000 hrs 65 ° C/85 with light: increase in recomb.; develop blocking contact

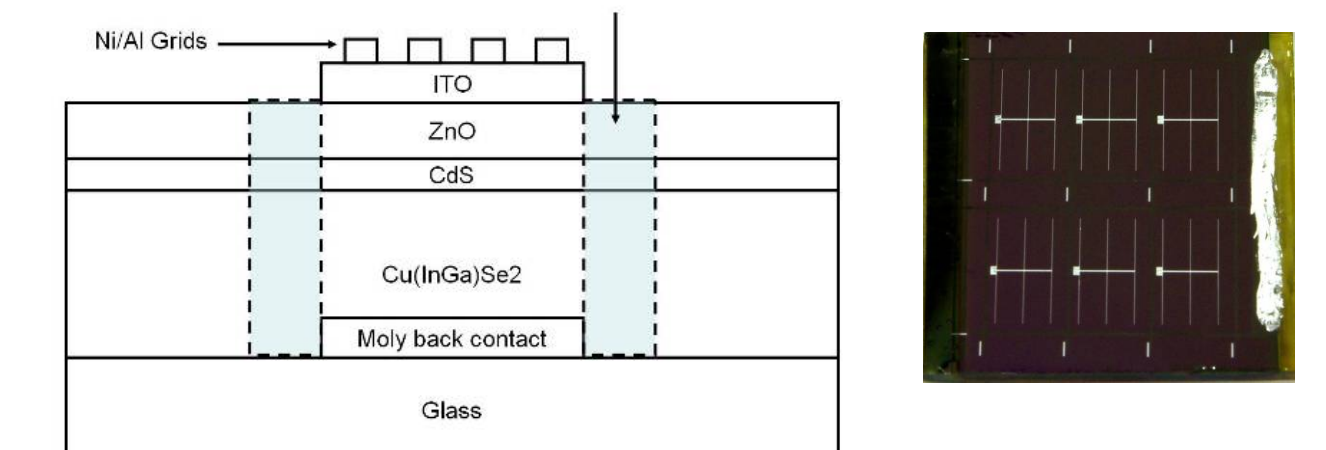
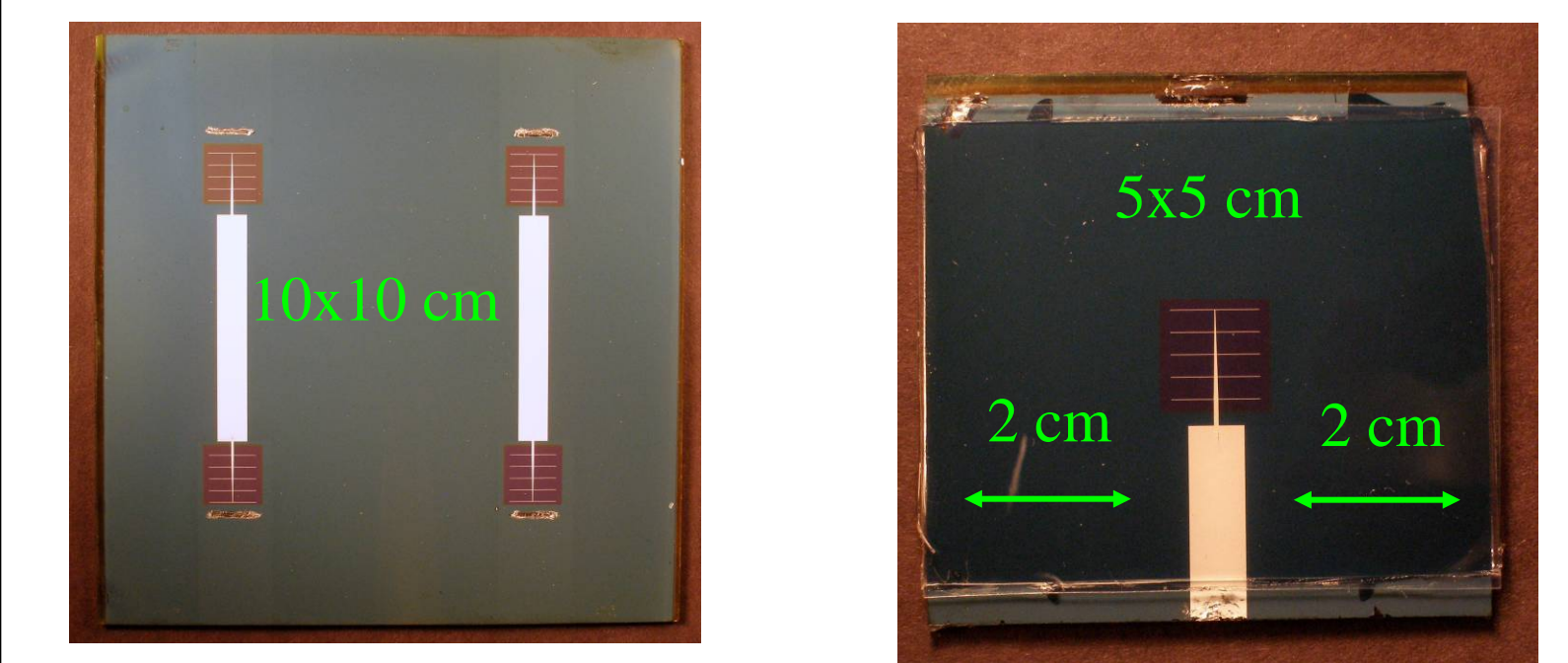


- LBIC of OPV module after D-H stress showing localized degradation

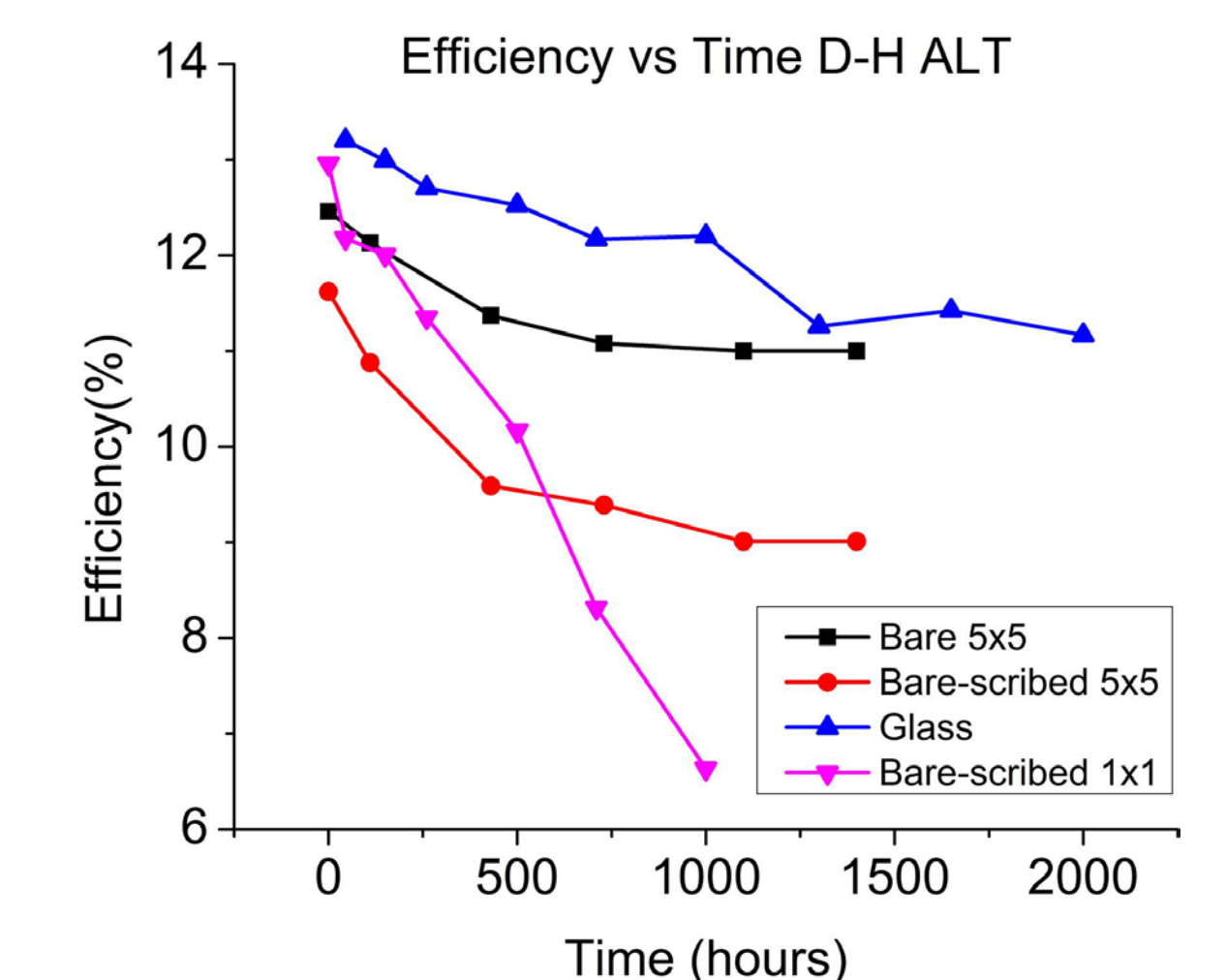


- Commercial CIGS mini module showing increased series resistance with D-H stress from galvanic corrosion between back contact and conductive tape due to encapsulation failure.

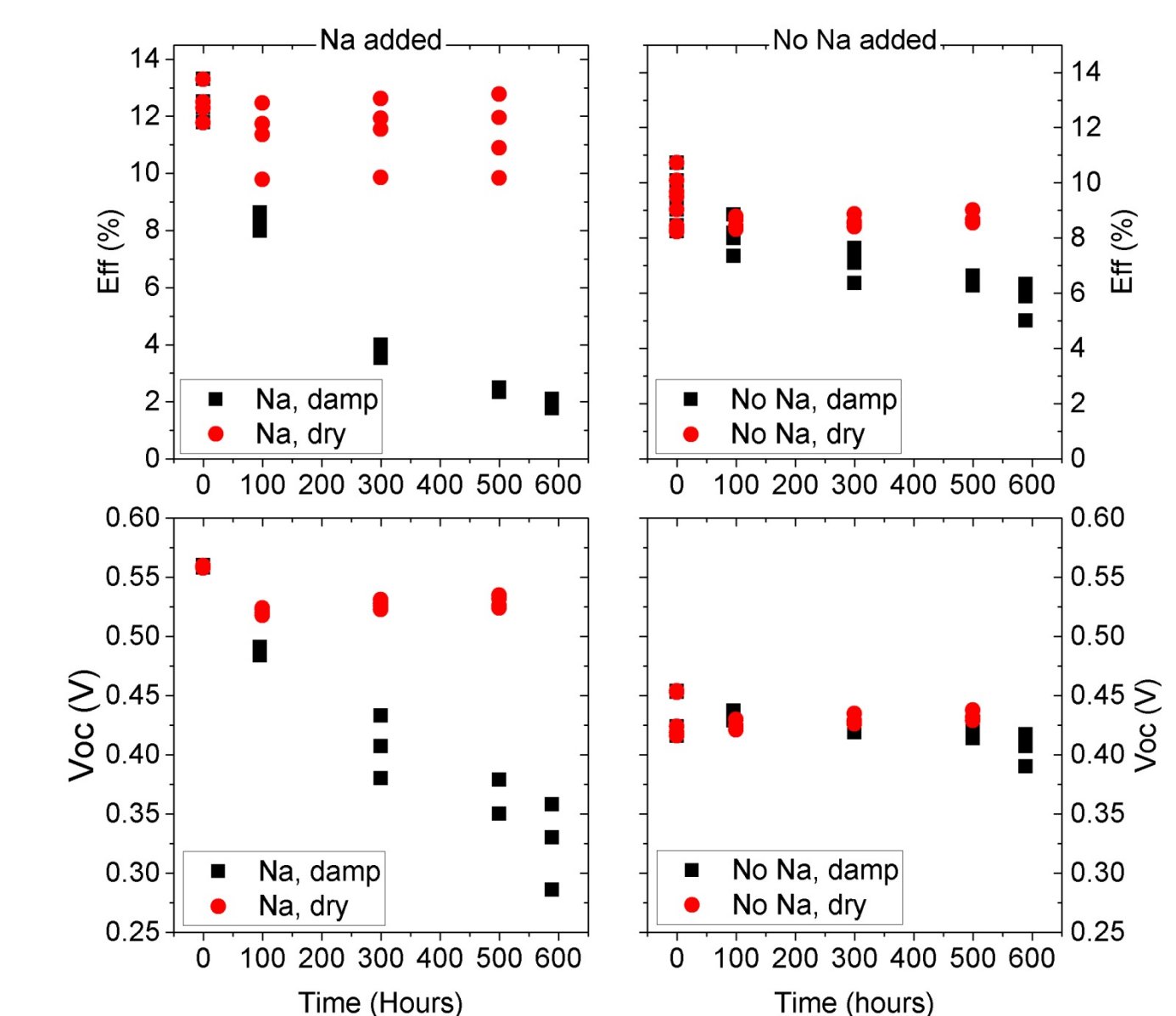
Test structures and device geometry



- Custom CIGS test structures and device fabricated at IEC for encapsulation testing to compare effect of scribing, lateral geometry



- TCO can act as water vapor barrier, scribes through TCO compromise D-H stability



- CIGS on stainless steel from commercial manufacturer, effects of damp and dry heat on devices with and without Na

CONCLUSIONS

- ALT under voltage and light bias critical to identify degradation and recovery modes
- In-situ IV characterization provides valuable insight on transients
- Device analysis separates junction recombination, series R, blocking contact
- Large area scanning techniques (LBIC, EL) identify shunts and localized losses